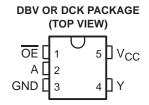
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- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outlline Transistor (DBV, DCK) Packages



description

The SN74AHCT1G125 is a single bus buffer gate/line driver with 3-state output. The output is disabled when the output-enable (\overline{OE}) input is high. When \overline{OE} is low, true data is passed from the A input to the Y output.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74AHCT1G125 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

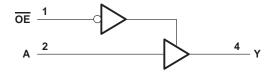
INPUTS		OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	Χ	Z

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Output voltage range, VO (see Note 1)	0.5 V to V _{CC} + 0.5 V
Input clamp current, $I_{ K }(V_{ C } < 0)$	–20 mA
Output clamp current, IOK (VO < 0 or VO > VCC)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): DBV package .	347°C/W
DCK package .	389°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
V _{IL}	Low-level input voltage		0.8	V
٧ı	Input voltage	0	5.5	V
٧o	Output voltage	0	VCC	V
ЮН	High-level output current		-8	mA
loL	Low-level output current		8	mA
Δt/Δν	Input transition rise or fall rate		20	ns/V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	vcc	T _A = 25°C			MIN	MAX	UNIT
	TEST CONDITIONS		MIN	TYP	MAX	IVIIIV	IVIAA	UNIT
Voн	I _{OH} = -50 μA	4.5 V	4.4	4.5		4.4		V
VOH	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		
Voi	I _{OL} = 50 μA	4.5 V			0.1		0.1	V
VOL	I _{OL} = 8 mA				0.36		0.44	
ΙĮ	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.25		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
Δl _{CC} ‡	One input at 3.4 V, Other input at V _{CC} or GND	5.5 V			1.35		1.5	mA
C _i	$V_I = V_{CC}$ or GND	5 V		4	10		10	pF
Co	$V_O = V_{CC}$ or GND	5 V		10				pF

[‡] This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51.

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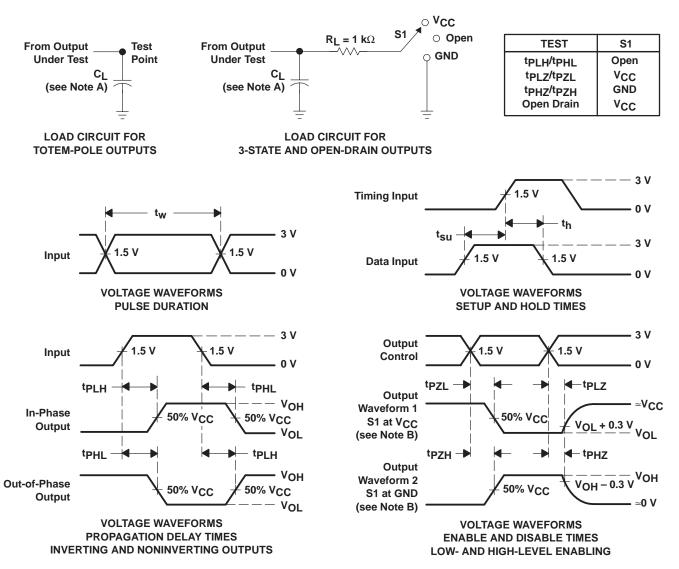
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD CAPACITANCE	T _A = 25°C			MIN	MAX	UNIT					
PARAMETER	(INPUT)	(OUTPUT)		MIN	TYP	MAX	IVIIIV	WAX	UNII					
^t PLH	А	Y	V	V	0 45 = 5		3.8	5.5	1	6.5	ns			
^t PHL	A		C _L = 15 pF		3.8	5.5	1	6.5	115					
^t PZH	ŌĒ	Y	C _L = 15 pF		3.6	5.1	1	6	ns					
t _{PZL}	OE		'	ſ	ĭ	ī	ī	 	OL = 13 pr		3.6	5.1	1	6
^t PHZ	ŌĒ	Y	C _L = 15 pF		4.6	6.8	1	8						
^t PLZ					4.6	6.8	1	8	ns					
^t PLH	А	Y	C _L = 50 pF		5.3	7.5	1	8.5	ns					
^t PHL	Α		OL = 30 pr		5.3	7.5	1	8.5	115					
^t PZH	ŌĒ	Y	C _L = 50 pF		5.1	7.1	1	8	20					
tPZL		r	CL = 50 pF		5.1	7.1	1	8	ns					
^t PHZ	ŌĒ	Y	Y	Y	V C: 50 pF		6.1	8.8	1	10	ns			
^t PLZ					C _L = 50 pF		6.1	8.8	1	10	118			

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER		TEST C	ONDITIONS	TYP	UNIT
Γ	C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	14	pF

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_I includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_\Gamma \leq 3$ ns. $t_f \leq 3$ ns.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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